



A Product Line of Diodes Incorporated



### **50V NPN LOW SATURATION POWER TRANSISTOR IN SOT89**

### Features

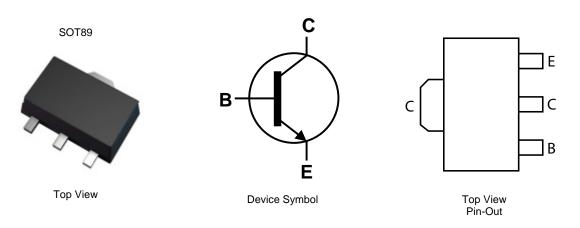
- BV<sub>CEO</sub> > 50V
- I<sub>C</sub> = 3A high Continuous Collector Current
- I<sub>CM</sub> up to 6A Peak Pulse Current
- 2W Power Dissipation
- Low saturation voltage V<sub>CE(sat)</sub> < 220mV @ 1A</li>
- R<sub>CE(sat)</sub> = 87mΩ @ 2.75A for a low equivalent on-resistance
- h<sub>FE</sub> characterised up to 6A for high current gain hold-up
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

## **Mechanical Data**

- Case: SOT89
- Case Material: Molded Plastic, "Green" Molding Compound
- UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (@);
- Weight: 0.052 grams (Approximate)

## Applications

- Load Management Functions
- Motor Control
- DC-DC / DC-AC Converters



## Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
FCX619TA	619	7	12	1,000
FCX619-13R	619	13	12	4,000

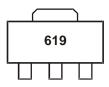
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html

## **Marking Information**



619 = Product Type Marking Code





#### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V <sub>CBO</sub>	50	V
Collector-Emitter Voltage	V <sub>CEO</sub>	50	V
Emitter-Base Voltage	V <sub>EBO</sub>	7	V
Continuous Collector Current	Ic	3	A
Peak Pulse Current	I <sub>CM</sub>	6	A
Continuous Base Current	IB	500	mA

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

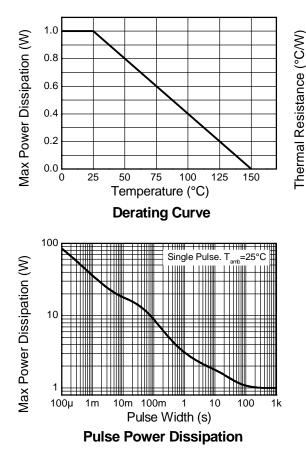
Characteristic	Symbol	Value	Unit		
Power Dissipation	(Note 5)	Р	1	W	
	(Note 6)	PD	2	vv	
Thermal Desistance Junction to Ambient Air	(Note 5)	D	125	°C/W	
Thermal Resistance, Junction to Ambient Air	(Note 6)	R <sub>θJA</sub>	62.5		
Thermal Resistance, Junction to Leads	(Note 7)	R <sub>θJL</sub>	5.73	°C/W	
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	۵°	

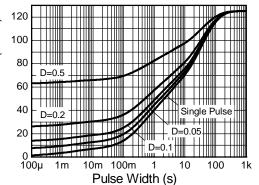
Notes: 5. For a device surface mounted on 15mm x 15mm x 0.6mm FR4 PCB with high coverage of single sided 1 oz copper, in still air conditions; the device is measured when operating in steady state condition.

6. Same as note (5), except the device is mounted on 40mm x 40mm x 1.6mm FR4 PCB.

7. Thermal resistance from junction to solder-point (on the exposed collector pad).

## Thermal Characteristics and Derating Information





Transient Thermal Impedance





# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

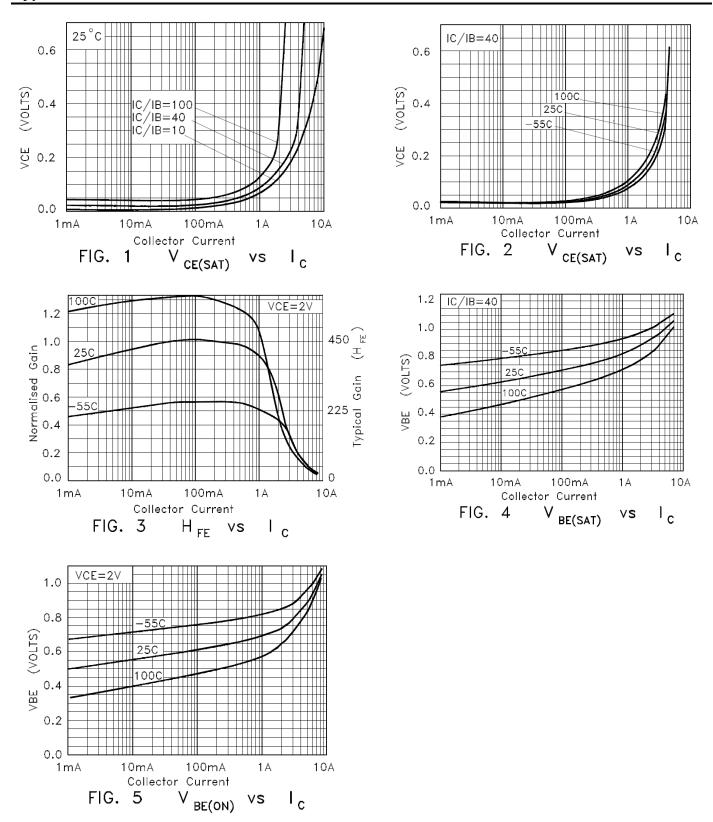
Characteristic	Symbol	Min	Тур.	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	50	190	—	V	I <sub>C</sub> = 100μA
Collector-Emitter Breakdown Voltage (Note 8)	BV <sub>CEO</sub>	50	65	_	V	$I_{C} = 10 \text{mA}$
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	7	8.3	—	V	I <sub>E</sub> = 100μA
Collector Cutoff Current	I <sub>CBO</sub>	—	_	100	nA	$V_{CB} = 40V$
Emitter Cutoff Current	I <sub>EBO</sub>	—	_	100	nA	V <sub>EB</sub> = 5.6V
Emitter Cutoff Current	I <sub>CES</sub>	—	—	100	nA	$V_{CES} = 40V$
DC current transfer Static ratio (Note 8)	h <sub>FE</sub>	200 300 200 100 —	400 450 400 200 30	_	_	$\label{eq:loss} \begin{array}{l} I_{C} = 10 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_{C} = 200 \text{mA}, \ V_{CE} = 2 \text{V} \\ I_{C} = 1 \text{A}, \ V_{CE} = 2 \text{V} \\ I_{C} = 2 \text{A}, \ V_{CE} = 2 \text{V} \\ I_{C} = 6 \text{A}, \ V_{CE} = 2 \text{V} \end{array}$
Collector-Emitter Saturation Voltage (Note 8)	V <sub>CE(sat)</sub>	_	13 150 190 240	25 220 260 320	V	$\label{eq:lc} \begin{array}{l} I_{C} = 100 \text{mA}, \ I_{B} = 10 \text{mA} \\ I_{C} = 1 \text{A}, \ I_{B} = 10 \text{mA} \\ I_{C} = 2 \text{A}, \ I_{B} = 50 \text{mA} \\ I_{C} = 2.75 \text{A}, \ I_{B} = 100 \text{mA} \end{array}$
Base-Emitter Saturation Voltage (Note 8)	V <sub>BE(sat)</sub>	—	0.97	1.1	V	I <sub>C</sub> = 2.75A, I <sub>B</sub> = 100mA
Base-Emitter Turn-on Voltage (Note 8)	V <sub>BE(on)</sub>	—	0.89	1.0	V	I <sub>C</sub> = 2.75A, V <sub>CE</sub> = 2V
Transitional Frequency	f⊤	100	165	_	MHz	I <sub>C</sub> = 50mA, V <sub>CE</sub> = 10V f = 100MHz
Output capacitance	Cobo		12	20	pF	V <sub>CB</sub> = 10V, f = 1MHz,
Turn-On Time	t <sub>(on)</sub>		170	_	ns	V <sub>CC</sub> =10V, I <sub>C</sub> =1A
Turn-Off Time	t <sub>(off)</sub>	_	750	_	ns	$I_{B1} = -I_{B2} = 10mA$

Note: 8. Measured under pulsed conditions. Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2%.





## Typical Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

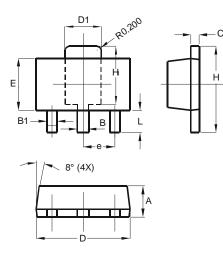






# **Package Outline Dimensions**

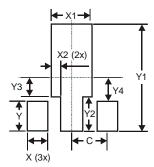
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT89				
Dim	Min	Max		
Α	1.40	1.60		
В	0.44	0.62		
B1	0.35	0.54		
С	0.35	0.44		
D	4.40	4.60		
D1	1.62	1.83		
Е	2.29	2.60		
е	1.50 Typ			
Н	3.94	4.25		
H1	2.63	2.93		
L	0.89	1.20		
All [	All Dimensions in mm			

## **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Х	0.900
X1	1.733
X2	0.416
Y	1.300
Y1	4.600
Y2	1.475
Y3	0.950
Y4	1.125
С	1.500





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